550W to 650W PTC Fan Heaters

Applications
These semiconductor positive temperature coefficient fan heaters prevent the formation of condensation and ensure an even temperature in enclosures. The integrated thermostat is used to set the desired temperature while the high performance axial fan provides forced air circulation.

Features
- Compact fan heater
- Heating power adjusts to ambient temperature
- Integrated adjustable thermostat
- Built-in overheat protection
- DIN rail mountable

<table>
<thead>
<tr>
<th>Part Number</th>
<th>Price</th>
<th>Heating capacity¹ (@ 60 Hz)</th>
<th>Operating Voltage (Min/Max)</th>
<th>Max. current (inrush)</th>
<th>Air flow, free blowing</th>
<th>Thermostat Range²</th>
<th>Weight (approx.)</th>
</tr>
</thead>
</table>
| 027009-00  | $148.00| 550W                        | 100-120V AC, 50/60 Hz       | 14.0 A                | 20 cfm [35 m³/h]       | 32 to 140°F       | 2.0 lb [907g]   
| 027009-01  | $148.00|                            | 220-240V AC, 50/60 Hz       | 11.0 A                |                        | 0 to 60°C         |                 
| 027019-00  | $164.00|                            | 100-120V AC, 50/60 Hz       | 15.0 A                | 26 cfm [45 m³/h]       | 0 to 60°C         | 2.4 lb [1089g]  
| 027019-01  | $164.00|                            | 220-240V AC, 50/60 Hz       | 13.0 A                |                        | 32 to 140°F       |                 

Notes:
¹ At 68°F [20°C] ambient temperature
² Switch difference 12.6 °F ±7°F [7K ±4K]

To obtain the most current agency approval information, see the Agency Approval Checklist section on the specific part number’s web page at www.AutomationDirect.com
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Dimensions:

Inches [mm]

Wiring Diagram

Note: Only connect the L and N1 terminals – N2 is not used and Grounding is not required.

Note: When wiring 230 volt units for North American installations “L” (line) and “N” (neutral) will be used as “L1” (line1) “L2” (line2) respectively with no neutral connection.

Please see our website www.AutomationDirect.com for complete engineering drawings.
Enclosure Heating and Heater Selection

Why Heat an Enclosure?
Today’s miniaturization of enclosure components results in high packing densities, which in turn results in higher temperatures within the enclosure. These high temperatures are harmful to electronic components. In response, cooling systems have become standard in many applications. However, just as critical and widely underestimated, are failures caused by the formation of moisture.

Under certain climatic conditions, moisture can build up not only in outdoor or poorly insulated enclosures, but also in highly protected and well-sealed enclosures.

Moisture and Failure
Moisture, especially when combined with aggressive gases and dust, causes atmospheric corrosion and can result in the failure of components such as circuit breakers, busbars, relays, integrated circuit boards and transformers. The greatest danger lies in conditions where electronic equipment is exposed to relatively high air humidity or extreme variations in temperature, such as day-and-night operation or outdoor installation. Failure of components in such cases is usually caused by changing contact resistances, flashovers, creepage currents or reduced insulation properties.

Eliminate Moisture
Moisture and corrosion will remain low if relative air humidity stays below 60%. However, relative humidity above 65% will significantly increase moisture and corrosion problems. This can be prevented by keeping the environment inside an enclosure at a temperature as little as 9°F (5°C) higher than that of the ambient air. Constant temperatures are a necessity to guarantee optimal operating conditions. Continuous temperature changes not only create condensation but they reduce the life expectancy of electronic components significantly. Electronic components can be protected by cooling during the day and heating at night.

Thermal Management
Modern enclosure heaters are designed to protect against condensation. They heat the air inside enclosures, preventing water vapor from condensing on components while providing the greatest possible air circulation and low energy consumption.

Other heating element technology improvements include:
- Longer operating life
- Greater energy efficiencies
- Quick wiring options
- Easier mounting
- Fan heaters should be considered for larger enclosures to ensure that the entire enclosure is heated uniformly

Heater Location
Ideally, most heaters will perform optimally when mounted near the bottom of an enclosure and used in conjunction with a control device, thermostat, and/or hygrostat. The control device may be a separate device, or it may be integral to the heater. With the controller located in an area of the cabinet that is representative of the average temperature or humidity requirement, the heater should then be placed in a position near the bottom of the enclosure. If a separate control device is used, the heater should not be located directly beneath the controller to ensure that the controller is not influenced by direct heat from the heater.

Heater Calculation
Follow Steps 1-5 to determine the heating requirement of an enclosure (US units - left column, metric - right)

STEP 1: Determine the Surface Area (A) of your enclosure which is exposed to open air.

Enclosure Dimensions:
height = ________ feet ________ meters
width = ________ feet ________ meters
depth = ________ feet ________ meters

Choose Mounting Option from next page, and calculate the surface area as indicated

A = ________ ft² or ________ m²

STEP 2: Choose the Heat Transmission Coefficient (k) for your enclosure’s material of construction.

- painted steel = 0.511 W/(ft²•K)   5.5 W/(m²•K)
- stainless steel = 0.344 W/(ft²•K)  3.7 W/(m²•K)
- aluminum = 1.115 W/(ft²•K)   12 W/(m²•K)
- plastic or insulated stainless = 0.325 W/(ft²•K)  3.5 W/(m²•K)

k = ________W/(ft²•K) or ________ W/(m²•K)

STEP 3: Determine the Temperature Differential (ΔT).

A. Desired enclosure interior temp. = ____°F      ____°C
B. Lowest ambient (outside) temp.   = ____°F      ____°C

Subtract B from A = Temp. diff. (ΔT) =     ____°F      ____°C

For these calculations, ΔT must be in degrees Kelvin (K). Therefore, divide ΔT (°F) by 1.8. ΔT = ________ K

STEP 4: Determine Heating Power (Pᵥ), if any (generated from existing components, i.e. transformer).

PV = ________ W or ________ W

STEP 5: Calculate the Required Heating Power (PH) for your enclosure based on the above values.

If enclosure is located inside:

PH = (A x k x ΔT) - PV = __________ W

If enclosure is located outside:

PH = 2 x (A x k x ΔT) - PV = __________ W
Enclosure Mounting Types and Surface Area Calculations

1. Free-Standing

\[
\text{Area (A)} = 1.8 (H \times W) + 1.8 (H \times D) + 1.8 (W \times D)
\]

2. Wall-Mounted

\[
\text{Area (A)} = 1.4 (H \times W) + 1.8 (H \times D) + 1.8 (W \times D)
\]

3. Ground

\[
\text{Area (A)} = 1.8 (H \times W) + 1.8 (H \times D) + 1.4 (W \times D)
\]

4. Ground and Wall

\[
\text{Area (A)} = 1.4 (H \times W) + 1.8 (H \times D) + 1.4 (W \times D)
\]